8-Bit Addressable Latch 1-of-8 Decoder with LSTTL Inputs

High–Performance Silicon–Gate CMOS

The MC74HCT259A is identical in pinout to the LS259. The device inputs are compatible with standard CMOS and LSTTL outputs.

The HCT259A has four modes of operation as shown in the mode selection table. In the addressable latch mode, the data on Data In is written into the addressed latch. The addressed latch follows the data input with all non-addressed latches remaining in their previous states. In the memory mode, all latches remain in their previous state and are unaffected by the Data or Address inputs. In the one-of-eight decoding or demultiplexing mode, the addressed output follows the state of Data In with all other outputs in the LOW state. In the Reset mode all outputs are LOW and unaffected by the address and data inputs. When operating the HCT259A as an addressable latch, changing more than one bit of the address could impose a transient wrong address. Therefore, this should only be done while in the memory mode.

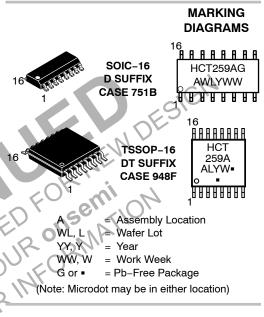
Features

- Outputs Directly Interface to CMOS, NMOS, and TTL
 Operating Voltage Ranges 4.5 and 5 and 5
- Low Input Current: 1 µA
- THIS DEVICE REPRESENTATION ON CHISING OF CHI High Noise Immunity Characteristic of CMOS Devices
- These are Pb-Free Devices



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PIN ASSIGNMENT

A0 [1•	16] V _{CC}
A1 [2	15] RESET
A2 [3	14] ENABLE
Q0 [4	13] data in
Q1 [5	12] Q7
Q2 [6	11] Q6
Q3 [7	10] Q5
GND [8	9] Q4
			•

MODE SELECTION TABLE

Enable	Reset	Mode
L	Н	Addressable Latch
Н	Н	Memory
L	L	8-Line Demultiplexer
Н	L	Reset

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 6 of this data sheet.

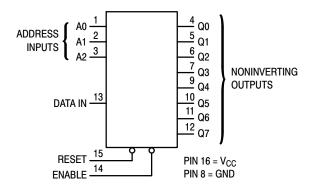


Figure 1. Logic Diagram

MAXIMUM RATINGS

LATCH SELECTION TABLE

Address Inputs		uts	
С	в	Α	Latch Addressed
			Q0 Q1 Q2 Q3 Q4 Q5 Q6 Q7

Symbol	Parameter	Value	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	-0.5 to +7.0	V
V _{in}	DC Input Voltage (Referenced to GND)	-0.5 to V _{CC} + 0.5	V
V _{out}	DC Output Voltage (Referenced to GND)	–0.5 to V _{CC} + 0.5	V
l _{in}	DC Input Current, per Pin	±20	mA
I _{out}	DC Output Current, per Pin	±25	mA
I _{CC}	DC Supply Current, V _{CC} and GND Pins	±50	mA
P _D	Power Dissipation in Still Air, SOIC Package TSSOP Package	500 450	mW
T _{stg}	Storage Temperature	-65 to + 150	°C
V _{ESD}	ESD Withstand Voltage Human Body Model (Note 1) Machine Model (Note 2)	>2000 >200	WF
I _{Latchup}	Latchup Performance Above V _{DD} and Below GND at 125°C (Note 3)	±100	mA

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation, V_{in} and Vout should be constrained to the range GND \leq (V_{in} or V_{out}) \leq V_{CC}. Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or V_{CC}). Unused outputs must be left open.

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- Tested to EIA / JESD22-A114-A. 1. Tested to EIA / JESD22-A115-A.
- 2.
- 3. Tested to EIA / JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Max	Unit
V _{CC}	DC Supply Voltage (Referenced to GND)	4.5	5.5	V
V _{in} , V _{out}	DC Input Voltage, Output Voltage (Referenced to GND)	0	V _{CC}	V
T _A	Operating Temperature, All Package Types	-55	+125	°C
t _r , t _f	Input Rise and Fall Time (Figure 2)	0	500	ns

				Gu	aranteed Li	mit	
Symbol	Parameter	Test Conditions	V _{CC} V	- 55 to 25°C	≤ 85°C	≤ 125°C	Unit
V _{IH}	Minimum High-Level Input Voltage	$ \begin{aligned} V_{out} &= 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ I_{out} &\leq 20 \ \mu A \end{aligned} $	4.5 5.5	2.0 2.0	2.0 2.0	2.0 2.0	V
V _{IL}	Maximum Low-Level Input Voltage	$ \begin{aligned} V_{out} &= 0.1 \text{ V or } V_{CC} - 0.1 \text{ V} \\ I_{out} &\leq 20 \ \mu A \end{aligned} $	4.5 5.5	0.8 0.8	0.8 0.8	0.8 0.8	V
V _{OH}	Minimum High-Level Output Voltage	$ \begin{aligned} V_{in} &= V_{IH} \text{ or } V_{IL} \\ I_{out} &\leq 20 \ \mu A \end{aligned} $	4.5 5.5	4.4 5.4	4.4 5.4	4.4 5.4	V
		$V_{in} = V_{IH} \text{ or } V_{IL} I_{out} \le 5.2 \text{ mA}$	4.5	3.98	3.84	3.70	
V _{OL}	Maximum Low-Level Output Voltage		4.5 5.5	0.1 0.1	0.1 0.1	0.1 0.1	V
		$V_{in} = V_{IH} \text{ or } V_{IL} I_{out} \le 5.2 \text{ mA}$	4.5	0.26	0.33	0.40	
I _{in}	Maximum Input Leakage Current	V _{in} = V _{CC} or GND	5.5	±0,1	± 1.0	± 1.0	μA
I _{CC}	Maximum Quiescent Supply Current (per Package)	$V_{in} = V_{CC} \text{ or } GND$ $I_{out} = 0 \ \mu A$	5.5	4	40	160	μA
ΔI_{CC}	Additional Quiescent Supply Current	V_{in} = 2.4V, Any One Input V_{in} = V _{CC} or GND, Other Inputs I_{out} = 0µA	5.5	≥ -55°C 2.9	25 to		mA

DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

		I _{out} = 0μA		5.5 2.9	
-11	AIS DEVICE PLE REP	OT RECON	NIMENT TACTO	DED ons	MATIO

AC ELECTRICAL CHARACTERISTICS (V_{CC} = 4.5 to 5.5 V, C_L = 50 pF, Input $t_r = t_f = 6$ ns)

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Symbol	Parameter	–55 to 25°C	≤ 85°C	≤ 125°C	Unit
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Data to Output (Figures 2 and 7)	32	32	42	ns
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Address Select to Output (Figures 3 and 7)	32	40	45	ns
t _{PLH} , t _{PHL}	Maximum Propagation Delay, Enable to Output (Figures 4 and 7)	32	40	45	ns
t _{PHL}	Maximum Propagation Delay, Reset to Output (Figures 5 and 7)	22	26	32	ns
t _{TLH} , t _{THL}	Maximum Output Transition Time, Any Output (Figures 2 and 7)	15	19	22	ns
C _{in}	Maximum Input Capacitance	10	10	10	pF

			Typical @ 25°C, V _{CC} = 5.0 V		
C _{PD}	Power Dissipation Capacitance (Per Package)		30	pF	
	QUIREMENTS ($V_{CC} = 4.5 \text{ to } 5.5 \text{ V}$. Input $t_r = t_f = 6 \text{ ns}$)		RNE		

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TIMING REQUIREMENTS (V_{CC} = 4.5 to 5.5 V, Input $t_r = t_f = 6$ ns)

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	Symbol	Parameter	-55 to 25°C	≤ 85°C	≤ 125°C	Unit
	t _{su}	Minimum Setup Time, Address or Data to Enable (Figure 6)	015	19	22	ns
	t _h	Minimum Hold Time, Enable to Address or Data (Figure 6)	1	1	1	ns
	t _w	Minimum Pulse Width, Reset or Enable (Figure 4 or 5)	15	19	22	ns
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SWITCHING WAVEFORMS

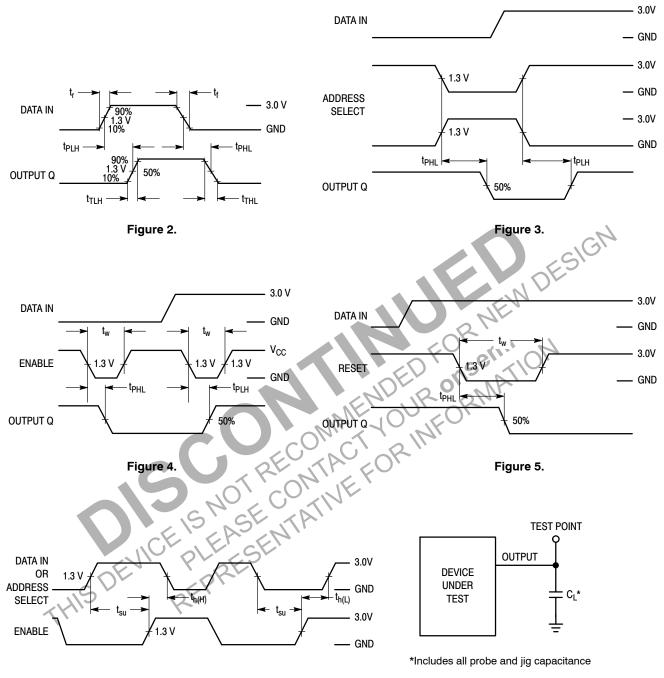
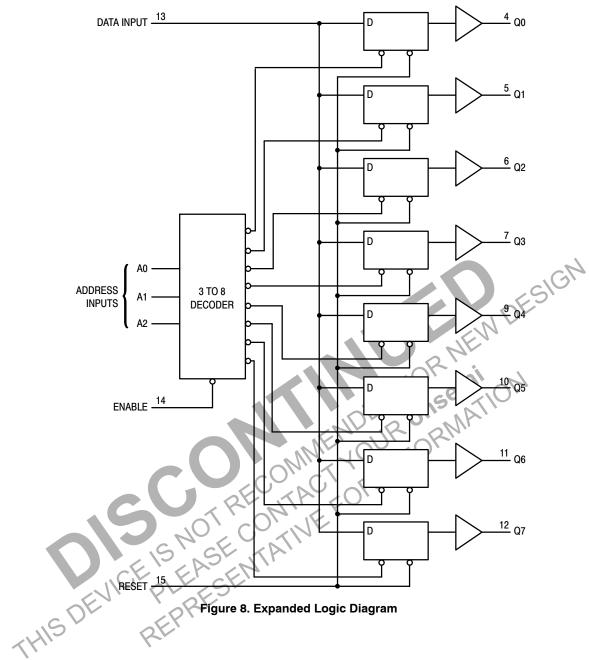


Figure 6.

Figure 7. Test Circuit



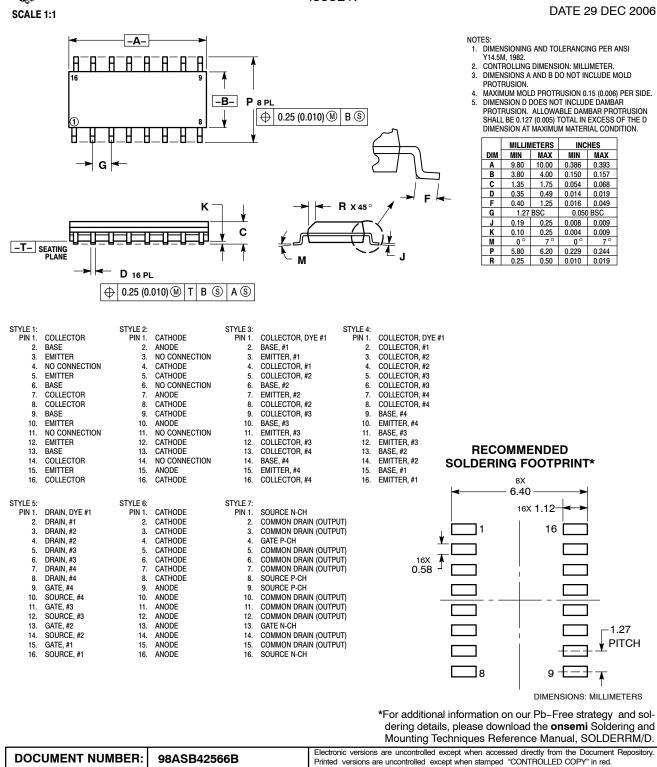
ORDERING INFORMATION

Device	Package	Shipping [†]
MC74HCT259ADG	SOIC-16 (Pb-Free)	48 Units / Rail
MC74HCT259ADR2G	SOIC-16 (Pb-Free)	2500 Tape & Reel
MC74HCT259ADTR2G	TSSOP-16*	2500 Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.
*This package is inherently Pb-Free.

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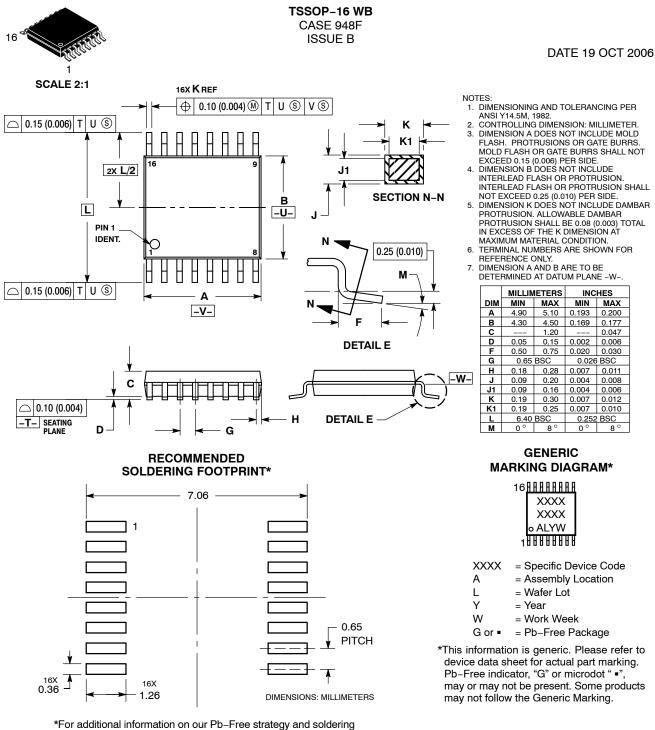
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MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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